











LMV7239-Q1

SNOSD85-APRIL 2018

# LMV7239-Q1 75-ns, Ultra Low Power, Low Voltage, Rail-to-Rail Input Comparator With Open-Drain and Push-Pull Output

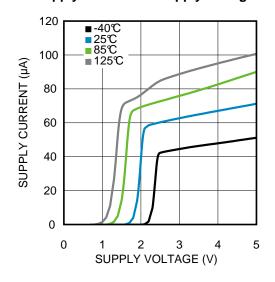
#### 1 Features

- · Qualified for Automotive Applications
- AEC-Q100 Qualified With the Following Results:
  - Device Temperature Grade 1: –40°C to 125°C
     Ambient Operating Temperature Range
  - Device HBM ESD Classification Level 1C
  - Device CDM ESD Classification Level C5 for the DBV Package
- V<sub>S</sub> = 5 V, T<sub>A</sub> = 25°C (Typical Values Unless Otherwise Specified)
- Propagation Delay: 75 ns
- Low supply Current: 65 μA
- Rail-to-Rail Input
- Open Drain and Push-Pull Output
- Ideal for 2.7-V and 5-V, Single-Supply Applications
- Available in Space-Saving Packages:
  - 5-Pin SOT-23
  - 5-Pin SC70

### 2 Applications

- Portable and Battery-Powered Systems
- Set Top Boxes
- · High-Speed Differential Line Receiver
- Window Comparators
- · Zero-Crossing Detectors
- High-Speed Sampling Circuits

#### Supply Current vs. Supply Voltage



### 3 Description

The LMV7239-Q1 is a ultra low power, low voltage, 75-ns comparator. It is ensured to operate over the full supply voltage range of 2.7 V to 5.5 V. This device achieves a 75-ns propagation delay while consuming only  $65 \,\mu\text{A}$  of supply current at 5 V.

The LMV7239-Q1 has a greater than rail-to-rail common-mode voltage range. The input common mode voltage range extends 200 mV below ground and 200 mV above supply, allowing both ground and supply sensing.

The LMV7239-Q1 features a push-pull output stage. This feature allows operation without the need of an external pullup resistor.

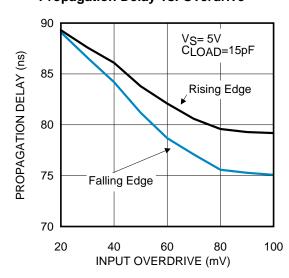
The LMV7239-Q1 is available in the 5-pin SC70 and 5-pin SOT-23 packages, which are ideal for systems where small size and low power is critical.

#### Device Information<sup>(1)</sup>

PART NUMBER	PACKAGES	BODY SIZE (NOM)
L B A V / 7000 O A	SOT-23 (5)	2.90 mm x 1.60 mm
LMV7239-Q1	SC70 (5)	2.00 mm x 1.25 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

#### Propagation Delay vs. Overdrive



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### **Table of Contents**

1	Features 1		7.4 Device Functional Modes	11
2	Applications 1	8	Application and Implementation	15
3	Description 1		8.1 Application Information	15
4	Revision History2		8.2 Typical Applications	
5	Pin Configuration and Functions	9	Power Supply Recommendations	18
6	Specifications4	10	Layout	. 19
•	6.1 Absolute Maximum Ratings 4		10.1 Layout Guidelines	19
	6.2 ESD Ratings 4		10.2 Layout Example	19
	6.3 Recommended Operating Conditions 4	11	Device and Documentation Support	20
	6.4 Thermal Information		11.1 Device Support	20
	6.5 Electrical Characteristics, 2.7 V5		11.2 Documentation Support	20
	6.6 Electrical Characteristics, 5 V		11.3 Receiving Notification of Documentation Update	s <mark>20</mark>
	6.7 Typical Characteristics		11.4 Community Resources	20
7	Detailed Description 10		11.5 Trademarks	20
	7.1 Overview		11.6 Electrostatic Discharge Caution	20
	7.2 Functional Block Diagram		11.7 Glossary	20
	7.3 Feature Description	12	Mechanical, Packaging, and Orderable Information	. 20

### 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

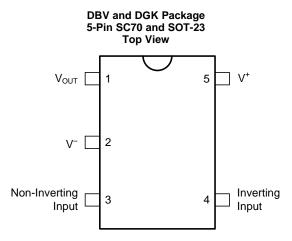
DATE	REVISION	NOTES
April 2018	*	Initial release. Moved the automotive device from the SNOS532 to a standalone data sheet and updated the input offset voltage parameter in the Electrical Characteristics, 2.7 V and Electrical Characteristics, 5 V tables

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## **5 Pin Configuration and Functions**



**Pin Functions** 

P	IN	I/O	DESCRIPTION				
NO.	NAME	1/0	DESCRIPTION				
1	V <sub>OUT</sub>	0	Output				
2	V <sup>-</sup>	Р	Negative Supply				
3	IN+	I	Noninverting Input				
4	IN-	I	Inverting Input				
5	V <sup>+</sup>	Р	Positive Supply				

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#### 6 Specifications

#### 6.1 Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

	MIN	MAX	UNIT
Differential Input Voltage		± Supply Voltage	V
Output Short Circuit Duration		See (2)	
Supply Voltage (V <sup>+</sup> - V <sup>-</sup> )		6	V
SOLDERING INFORMATION	·	<u> </u>	
Infrared or Convection (20 sec)		235	°C
Wave Soldering (10 sec)		260 (lead temp)	°C
Voltage at Input/Output Pins		(V <sup>+</sup> ) +0.3, (V <sup>−</sup> ) −0.3	V
Current at Input Pin (3)		±10	mA
Storage Temperature, T <sub>stg</sub>	<b>–65</b>	150	°C
Junction Temperature,T <sub>J</sub>		150	°C

<sup>(1)</sup> Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 ESD Ratings

				VALUE	UNIT
		Human-body model (HBM), per AEC Q100-002 <sup>(1)</sup>		±1000	
V <sub>(ESD)</sub> Electrostatic discharge	Charged-device model (CDM), per AEC Q100-011 (1)	DBV package only	±750	V	
uischarge		Machine model (MM)		±100	

JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 250-V CDM is possible with the necessary precautions.

6.3 Recommended Operating Conditions

	MIN	MAX	UNIT
Supply Voltages (V <sup>+</sup> - V <sup>-</sup> )	2.7	5.5	V
Temperature Range <sup>(1)</sup>	-40	125	°C

<sup>(1)</sup> The maximum power dissipation is a function of  $T_{J(MAX)}$ ,  $\theta_{JA}$ . The maximum allowable power dissipation at any ambient temperature is  $P_D = (T_{J(MAX)} - T_A) / \theta_{JA}$ . All numbers apply for packages soldered directly onto a PCB.

#### 6.4 Thermal Information

		LMV7239-Q1			
	THERMAL METRIC <sup>(1)</sup>	DGK (SC70)	DBV (SOT-23)	UNIT	
		5 PINS	5 PINS		
$R_{\theta JA}$	Junction-to-ambient thermal resistance	478	265	°C/W	

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

<sup>(2)</sup> Applies to both single-supply and split-supply operation. Continuous short circuit operation at elevated ambient temperature can result in exceeding the maximum allowed junction temperature of 150°C. Output currents in excess of ±30mA over long term may adversely affect reliability.

<sup>(3)</sup> Limiting input pin current is only necessary for input voltages that exceed absolute maximum input voltage ratings.



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### 6.5 Electrical Characteristics, 2.7 V

Unless otherwise specified, all limits ensured for  $T_A = 25$ °C,  $V_{CM} = V^+/2$ ,  $V^+ = 2.7$  V,  $V^- = 0$  V<sup>-</sup>.

	PARAMETER	TEST CO	MIN <sup>(1)</sup>	TYP <sup>(2)</sup>	MAX <sup>(1)</sup>	UNIT	
	land Offert Valtage			-6	±0.8	+6	mV
Vos	Input Offset Voltage	At temp extremes		-8		+8	
	1 15: 0				30	400	
I <sub>B</sub>	Input Bias Current	At temp extremes				600	nA
					5	200	
I <sub>OS</sub>	Input Offset Current	At temp extremes				400	nA
CMRR	Common-Mode Rejection Ratio	$0 \text{ V} < \text{V}_{\text{CM}} < 2.7 \text{ V}^{(3)}$		52	62		dB
PSRR	Power Supply Rejection Ratio	V <sup>+</sup> = 2.7 V to 5 V		65	85		dB
	Input Common-Mode Voltage Range	CMDD CO -ID		V⁻ -0.1	-0.2 to 2.9	V <sup>+</sup> +0.1	
$V_{CM}$		CMRR > 50 dB	At temp extremes	V-		V <sup>+</sup>	V
		I <sub>L</sub> = -4 mA, V <sub>ID</sub> = -500 mV		230	350		
$V_{O}$	Output Swing Low	At temp extremes				450	mV
		$I_L = -0.4 \text{ mA},$ $V_{ID} = -500 \text{ mV}$			15		
	Comple Compact	No load			52	85	
I <sub>S</sub>	Supply Current	At temp extremes				100	μA
		Overdrive = 20 mV C <sub>LOAD</sub> = 15 pF			96		ns
t <sub>PD</sub> Propagation Delay		Overdrive = 50 mV $C_{LOAD}$ = 15 pF			87		ns
		Overdrive = 100 mV C <sub>LOAD</sub> = 15 pF			85		ns
t <sub>r</sub>	Output Rise Time	LMV7239/LMV7239Q 10% to 90%			1.7		ns
t <sub>f</sub>	Output Fall Time	90% to 10%			1.7		ns

<sup>(1)</sup> All limits are ensured by testing or statistical analysis.

<sup>(2)</sup> Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested and are not guaranteed on shipped production material.

<sup>(3)</sup> CMRR is not linear over the common mode range. Limits are guaranteed over the worst case from 0 to V<sub>CC/2</sub> or V<sub>CC/2</sub> to V<sub>CC</sub>.



## 6.6 Electrical Characteristics, 5 V

Unless otherwise specified, all limits ensured for  $T_A = 25$ °C,  $V_{CM} = V^+/2$ ,  $V^+ = 5$  V,  $V^- = 0$  V.

	PARAMETER	ONDITIONS	MIN <sup>(1)</sup>	TYP <sup>(2)</sup>	MAX <sup>(1)</sup>	UNIT		
\/	Innuit Offact Voltage		-6	±1	+6	mV		
Vos	Input Offset Voltage	At temp extremes	-8		+8	mv		
	Innut Bing Comment				30	400	A	
I <sub>B</sub>	Input Bias Current	At temp extremes				600	nA	
	Innuit Officet Current				5	200	<b>~</b> Λ	
los	Input Offset Current	At temp extremes				400	nA	
CMRR	Common-Mode Rejection Ratio	0 V < V <sub>CM</sub> < 5 V		52	67		dB	
PSRR	Power Supply Rejection Ratio	V <sup>+</sup> = 2.7 V to 5 V		65	85		dB	
V <sub>CM</sub>	Input Common-Mode Voltage	CMRR > 50dB		V <sup>-</sup> −0.1	-0.2 to 5.2	V+ +0.1	V	
- CIVI	Range		At temp extremes	V-		V <sup>+</sup>		
		I <sub>L</sub> = −4 mA,			230	350		
Vo	Output Swing Low	V <sub>ID</sub> = −500 mV	At temp extremes			450	mV	
•0	Surput Swilling Low	$I_L = -0.4 \text{ mA},$ $V_{ID} = -500 \text{ mV}$			10			
	Supply Current	No load			65	95		
I <sub>S</sub>	Supply Current	NO IOAG	At temp extremes			110	μA	
		Overdrive = 20 mV $C_{LOAD}$ = 15 pF			89		ns	
t <sub>PD</sub> Propagation Delay	Propagation Delay	Overdrive = 50 mV C <sub>LOAD</sub> = 15 pF			82		ns	
		Overdrive = 100 mV C <sub>LOAD</sub> = 15 pF			75		ns	
t <sub>f</sub>	Output Fall Time	90% to 10%			1.2		ns	

<sup>(1)</sup> All limits are ensured by testing or statistical analysis.

Product Folder Links: LMV7239-Q1

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<sup>(2)</sup> Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested and are not guaranteed on shipped production material.



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6.7 Typical Characteristics

(Unless otherwise specified,  $V_S = 5V$ ,  $C_L = 10pF$ ,  $T_A = 25$ °C).

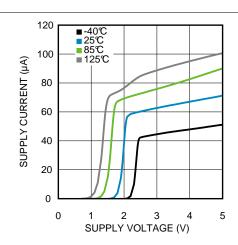


Figure 1. Supply Current vs. Supply Voltage

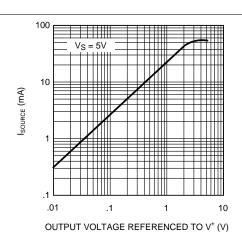


Figure 2. Sourcing Current vs. Output Voltage

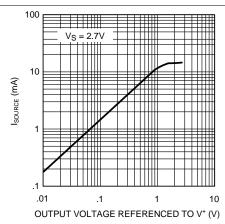


Figure 3. Sourcing Current vs. Output Voltage

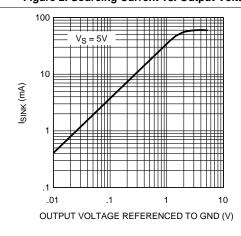


Figure 4. Sinking Current vs. Output Voltage

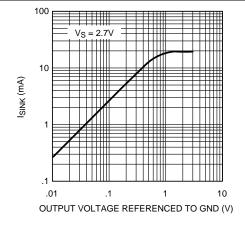


Figure 5. Sinking Current vs. Output Voltage

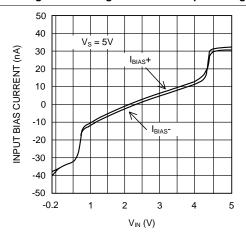


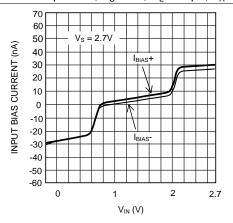
Figure 6. Input Bias Current vs. Input Voltage

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#### **Typical Characteristics (continued)**

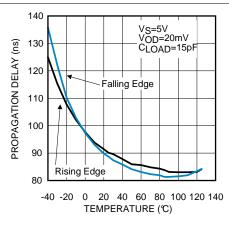
(Unless otherwise specified,  $V_S = 5V$ ,  $C_L = 10pF$ ,  $T_A = 25$ °C).



160 Vs=2.7V VOD=20mV CLOAD=15pF 150 PROPAGATION DELAY (ns) 140 130 Falling Edge 120 110 100 90 Rising Edge 80 -40 -20 0 20 40 60 80 100 120 140 TEMPERATURE (℃)

Figure 7. Input Bias Current vs. Input Voltage

Figure 8. Propagation Delay vs. Temperature



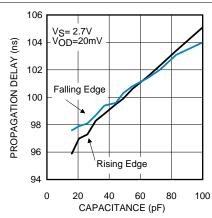
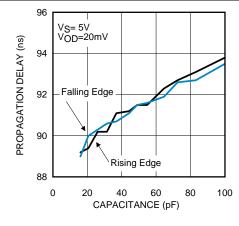


Figure 9. Propagation Delay vs. Temperature

Figure 10. Propagation Delay vs. Capacitive Load



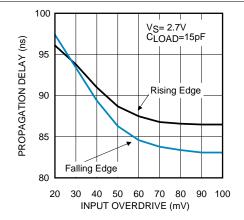


Figure 11. Propagation Delay vs. Capacitive Load

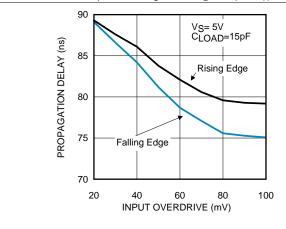
Figure 12. Propagation Delay vs. Input Overdrive



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## **Typical Characteristics (continued)**

(Unless otherwise specified,  $V_S = 5V$ ,  $C_L = 10pF$ ,  $T_A = 25$ °C).



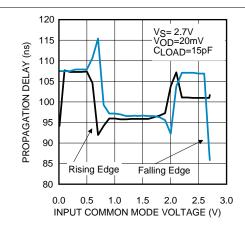


Figure 13. Propagation Delay vs. Input Overdrive

Figure 14. Propagation Delay vs. Common-Mode Voltage

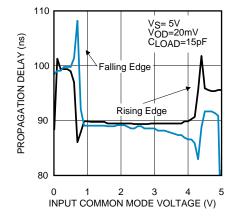


Figure 15. Propagation Delay vs. Common-Mode Voltage

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#### 7 Detailed Description

#### 7.1 Overview

The LMV7239-Q1 is an ultra low power, low voltage, 75-ns comparator. They are ensured to operate over the full supply voltage range of 2.7 V to 5.5 V. These devices achieve a 75-ns propagation delay while consuming only 65 µA of supply current at 5 V.

The LMV7239-Q1 has a greater than rail-to-rail common-mode voltage range. The input common-mode voltage range extends 200 mV below ground and 200 mV above supply, allowing both ground and supply sensing.

#### 7.2 Functional Block Diagram

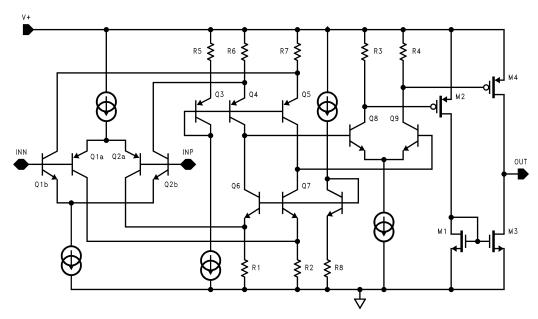


Figure 16. Simplified Schematic

#### 7.3 Feature Description

#### 7.3.1 Input Stage

The LMV7239-Q1 is a rail-to-rail input and output. The typical input common-mode voltage range of -0.2 V below the ground to 0.2 V above the supply. The LMV7239-Q1 uses a complimentary PNP and NPN input stage in which the PNP stage senses common-mode voltage near V and the NPN stage senses common-mode voltage near V<sup>+</sup>. If either of the input signals falls below the negative common mode limit, the parasitic PN junction formed by the substrate and the base of the PNP will turn on resulting in an increase of input bias current.

If one of the inputs goes above the positive common mode limit, the output will still maintain the correct logic level as long as the other input stays within the common mode range. However, the propagation delay will increase. When both inputs are outside the common-mode voltage range, current saturation occurs in the input stage, and the output becomes unpredictable.

The propagation delay does not increase significantly with large differential input voltages. However, large differential voltages greater than the supply voltage should be avoided to prevent damage to the input stage.

#### 7.3.2 Output Stage: LMV7239-Q1

The LMV7239-Q1 has a push-pull output. When the output switches, there is a low resistance path between V<sub>CC</sub> and ground, causing high output sinking or sourcing current during the transition.

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#### **Feature Description (continued)**

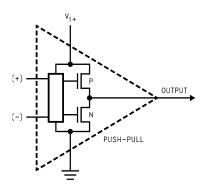


Figure 17. LMV7239-Q1 Push-Pull Output Stage

#### 7.4 Device Functional Modes

#### 7.4.1 Capacitive and Resistive Loads

The propagation delay is not affected by capacitive loads at the output of the LPV7239 or LMV7239-Q1. However, resistive loads slightly effect the propagation delay on the falling edge depending on the load resistance value.

#### 7.4.2 Noise

Most comparators have rather low gain. This allows the output to spend time between high and low when the input signal changes slowly. The result is the output may oscillate between high and low when the differential input is near zero. The high gain of this comparator eliminates this problem. Less than 1  $\mu$ V of change on the input will drive the output from one rail to the other rail. If the input signal is noisy, the output cannot ignore the noise unless some hysteresis is provided by positive feedback. (See *Hysteresis*.)

#### 7.4.3 Hysteresis

To improve propagation delay when low overdrive is needed hysteresis can be added.

#### 7.4.3.1 Inverting Comparator With Hysteresis

The inverting comparator with hysteresis requires a three resistor network that is referenced to the supply voltage  $V^+$  of the comparator as shown in Figure 18. When  $V_{IN}$  at the inverting input is less than  $V_A$ , the voltage at the noninverting node of the comparator ( $V_{IN} < V_A$ ), the output voltage is high (for simplicity assume  $V_O$  switches as high as  $V^+$ ). The three network resistors can be represented as  $R_1/R_3$  in series with  $R_2$ .

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#### **Device Functional Modes (continued)**

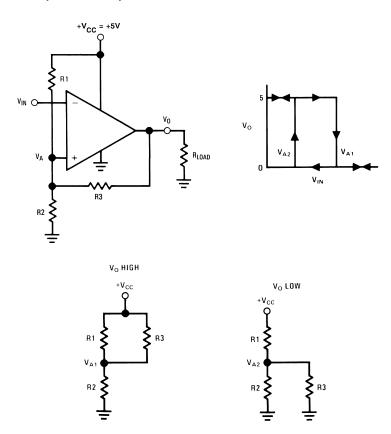


Figure 18. Inverting Comparator With Hysteresis

The lower input trip voltage V<sub>A1</sub> is defined as:

$$V_{A1} = V_{CC}R_2 / [(R_1 // R_3) + R_2)]$$
 (1)

When  $V_{IN}$  is greater than  $V_A$ , the output voltage is low or very close to ground. In this case the three network resistors can be presented as  $R_2 /\!\!/ R_3$  in series with  $R_1$ .

The upper trip voltage V<sub>A2</sub> is defined as:

$$V_{A2} = V_{CC} (R_2 /\!/ R_3) / [(R_1) + (R_2 /\!/ R_3)]$$
(2)

The total hysteresis provided by the network is defined as  $\Delta V_A = V_{A1} - V_{A2}$ .

$$\Delta V_{A} = \frac{+V_{CC}R_{1}R_{2}}{R_{1}R_{2} + R_{1}R_{3} + R_{2}R_{3}}$$
(3)

#### 7.4.3.2 Non-Inverting Comparator With Hysteresis

A noninverting comparator with hysteresis requires a two resistor network, and a voltage reference ( $V_{REF}$ ) at the inverting input. When  $V_{IN}$  is low, the output is also low. For the output to switch from low to high,  $V_{IN}$  must rise up to  $V_{IN1}$  where  $V_{IN1}$  is calculated by:

$$\Delta V_{IN1} = \frac{V_{REF}(R_1 + R_2)}{R_2} \tag{4}$$

As soon as V<sub>O</sub> switches to V<sub>CC</sub>, V<sub>A</sub> steps to a value greater than V<sub>REF</sub> which is given by:

$$V_{A} = V_{IN} + \frac{(V_{CC} - V_{IN1})R_{1}}{R_{1} + R_{2}}$$
 (5)

To make the comparator switch back to its low state,  $V_{IN}$  must equal  $V_{REF}$  before  $V_A$  will again equal  $V_{REF}$ .  $V_{IN2}$  can be calculated by:

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#### **Device Functional Modes (continued)**

$$V_{IN2} = \frac{V_{REF}(R_1 + R_2) - V_{CC} R_1}{R_2}$$
 (6)

The hysteresis of this circuit is the difference between  $V_{IN1}$  and  $V_{IN2}$ .

$$\Delta V_{IN} = V_{CC} R_1 / R_2 \tag{7}$$

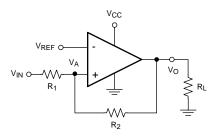


Figure 19. Noninverting Comparator With Hysteresis

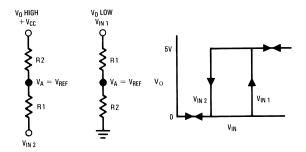


Figure 20. Noninverting Comparator Thresholds

#### 7.4.4 Zero Crossing Detector

In a zero crossing detector circuit, the inverting input is connected to ground and the noninverting input is connected to a 100 mV<sub>PP</sub> AC signal. As the signal at the noninverting input crosses 0V, the comparator's output changes state.

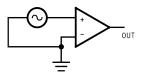


Figure 21. Simple Zero Crossing Detector

#### 7.4.4.1 Zero Crossing Detector With Hysteresis

To improve switching times and centering the input threshold to ground a small amount of positive feedback is added to the circuit. Voltage divider  $R_4$  and  $R_5$  establishes a reference voltage,  $V_1$ , at the positive input. By making the series resistance,  $R_1$  plus  $R_2$  equal to  $R_5$ , the switching condition,  $V_1 = V_2$ , will be satisfied when  $V_{IN}$ 

The positive feedback resistor,  $R_6$ , is made very large with respect to  $R_5 \parallel R_6 = 2000 \ R_5$ ). The resultant hysteresis established by this network is very small ( $\Delta V_1 < 10 \ mV$ ) but it is sufficient to insure rapid output voltage transitions.

Diode D<sub>1</sub> is used to ensure that the inverting input terminal of the comparator never goes below approximately -100 mV. As the input terminal goes negative, D<sub>1</sub> will forward bias, clamping the node between R<sub>1</sub> and R<sub>2</sub> to approximately -700 mV. This sets up a voltage divider with R<sub>2</sub> and R<sub>3</sub> preventing V<sub>2</sub> from going below ground. The maximum negative input overdrive is limited by the current handling ability of D<sub>1</sub>.

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#### **Device Functional Modes (continued)**

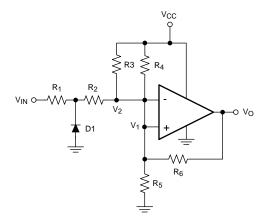


Figure 22. Zero Crossing Detector With Hysteresis

#### 7.4.5 Threshold Detector

Instead of tying the inverting input to 0 V, the inverting input can be tied to a reference voltage. As the input on the noninverting input passes the  $V_{REF}$  threshold, the comparator's output changes state. It is important to use a stable reference voltage to ensure a consistent switching point.

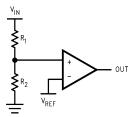


Figure 23. Threshold Detector

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#### 8 Application and Implementation

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

#### 8.1 Application Information

The LMV7239-Q1 is a single supply comparator with 75 ns of propagation delay and only 65  $\mu A$  of supply current.

#### 8.2 Typical Applications

#### 8.2.1 Square Wave Oscillator

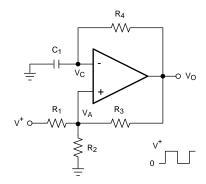


Figure 24. Square Wave Oscillator

#### 8.2.1.1 Design Requirements

A typical application for a comparator is as a square wave oscillator. The circuit in Figure 24 generates a square wave whose period is set by the RC time constant of the capacitor  $C_1$  and resistor  $R_4$ .

#### 8.2.1.2 Detailed Design Procedure

The maximum frequency is limited by the large signal propagation delay of the comparator and by the capacitive loading at the output, which limits the output slew rate.

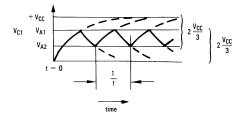


Figure 25. Square Wave Oscillator Timing Thresholds

Consider the output of Figure 24 to be high to analyze the circuit. That implies that the inverted input  $(V_C)$  is lower than the noninverting input  $(V_A)$ . This causes the  $C_1$  to be charged through  $R_4$ , and the voltage  $V_C$  increases until it is equal to the noninverting input. The value of  $V_A$  at this point is:

$$V_{A1} = \frac{V_{CC} \cdot R_2}{R_2 + R_1 \parallel R_3} \tag{8}$$

If  $R_1 = R_2 = R_3$ , then  $V_{A1} = 2 V_{cc}/3$ 

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#### **Typical Applications (continued)**

At this point the comparator switches pulling down the output to the negative rail. The value of V<sub>A</sub> at this point is:

$$V_{A2} = \frac{V_{CC}(R_2 \parallel R_3)}{R_1 + (R_2 \parallel R_3)}$$
(9)

If  $R_1 = R_2 = R_3$ , then  $V_{A2} = V_{CC}/3$ .

The capacitor  $C_1$  now discharges through  $R_4$ , and the voltage  $V_C$  decreases until it is equal to  $V_{A2}$ , at which point the comparator switches again, bringing it back to the initial stage. The time period is equal to twice the time it takes to discharge  $C_1$  from  $2V_{CC}/3$  to  $V_{CC}/3$ , which is given by  $R_4C_1$ ·In2. Hence the formula for the frequency is:

$$F = 1/(2 \cdot R_4 \cdot C_1 \cdot \ln 2) \tag{10}$$

The LMV7239 should be used for a symmetrical output. The LMV7235 will require a pullup resistor on the output to function, and will have a slightly asymmetrical output due to the reduced sourcing current.

#### 8.2.1.3 Application Curves

Figure 26 shows the simulated results of an oscillator using the following values:

- 1.  $R_1 = R_2 = R_3 = R_4 = 100 \text{ k}\Omega$
- 2.  $C_1 = 100 \text{ pF}, C_1 = 20 \text{ pF}$
- 3. V+ = 5 V, V- = GND
- 4.  $C_{STRAY}$  (not shown) from Va to GND = 10 pF

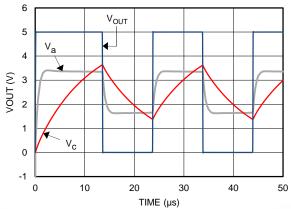


Figure 26. Square Wave Oscillator Output Waveform

#### 8.2.2 Crystal Oscillator

A simple crystal oscillator using the LMV7239-Q1 is shown in Figure 27. Resistors  $R_1$  and  $R_2$  set the bias point at the comparator's noninverting input. Resistors,  $R_3$  and  $R_4$  and capacitor  $C_1$  set the inverting input node at an appropriate DC average level based on the output. The crystal's path provides resonant positive feedback and stable oscillation occurs. The output duty cycle for this circuit is roughly 50%, but it is affected by resistor tolerances and to a lesser extent by the comparator

16 *Sub* 

#### **Typical Applications (continued)**

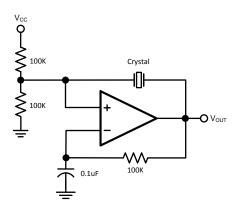


Figure 27. Crystal Oscillator

#### 8.2.3 Infrared (IR) Receiver

The LMV7239-Q1 can also be used as an infrared receiver. The infrared photo diode creates a current relative to the amount of infrared light present. The current creates a voltage across RD. When this voltage level cross the voltage applied by the voltage divider to the inverting input, the output transitions.

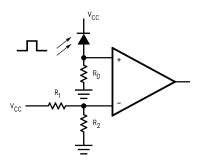


Figure 28. IR Receiver

#### 8.2.4 Window Detector

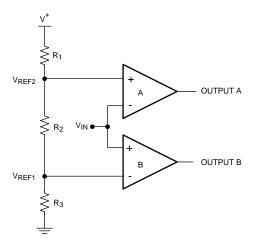


Figure 29. Window Detector

A window detector monitors the input signal to determine if it falls between two voltage levels. Both outputs are true (high) when  $V_{REF1} < V_{IN} < V_{REF2}$ 

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#### **Typical Applications (continued)**

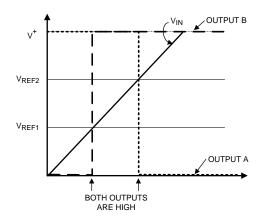


Figure 30. Window Detector Output Signal

The comparator outputs A and B are high only when  $V_{REF1} < V_{IN} < V_{REF2}$ , or "within the window", where these are defined as:

$$V_{REF1} = R_3/R_1 + R_2 + R_3) \times V + \tag{11}$$

$$V_{REF2} = R_2 + R_3/R_1 + R_2 + R_3) \times V + \tag{12}$$

To determine if the input signal falls outside of the two voltage levels, both inputs on each comparators can be reversed to invert the logic.

Other names for window detectors are: threshold detector, level detector, and amplitude trigger or detector.

### 9 Power Supply Recommendations

To minimize supply noise, power supplies should be decoupled by a 0.01- $\mu$ F ceramic capacitor in parallel with a 10- $\mu$ F capacitor.

Due to the nanosecond edges on the output transition, peak supply currents will be drawn during the time the output is transitioning. Peak current depends on the capacitive loading on the output. The output transition can cause transients on poorly bypassed power supplies. These transients can cause a poorly bypassed power supply to "ring" due to trace inductance and low self-resonance frequency of high ESR bypass capacitors.

Treat the LMV7239-Q1 as a high-speed device. Keep the ground paths short and place small (low ESR ceramic) bypass capacitors directly between the V+ and V- pins.

Output capacitive loading and output toggle rate will cause the average supply current to rise over the quiescent current.

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#### 10 Layout

#### 10.1 Layout Guidelines

Proper grounding and the use of a ground plane will help to ensure the specified performance of the LMV7239-Q1. Minimizing trace lengths, reducing unwanted parasitic capacitance and using surface-mount components will also help. Comparators are very sensitive to input noise.

The LMV7239-Q1 requires a high-speed layout. Follow these layout guidelines:

- 1. Use printed-circuit board with a good, unbroken low-inductance ground plane.
- 2. Place a decoupling capacitor (0.1-μF, ceramic surface-mount capacitor) as close as possible to V<sub>CC</sub> pin.
- 3. On the inputs and the output, keep lead lengths as short as possible to avoid unwanted parasitic feedback around the comparator. Keep inputs away from output.
- 4. Solder the device directly to the printed-circuit board rather than using a socket.
- 5. For slow moving input signals, take care to prevent parasitic feedback. A small capacitor (1000 pF or less) placed between the inputs can help eliminate oscillations in the transition region. This capacitor causes some degradation to t<sub>PD</sub> when the source impedance is low.
- 6. The top-side ground plane runs between the output and inputs.
- 7. Ground trace from the ground pin runs under the device up to the bypass capacitor, shielding the inputs from the outputs.

#### 10.2 Layout Example

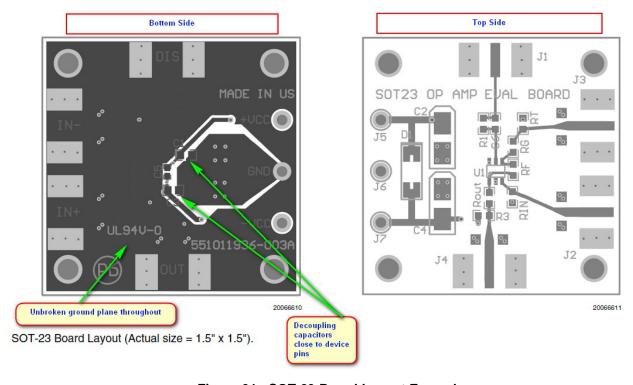


Figure 31. SOT-23 Board Layout Example

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## TEXAS INSTRUMENTS

#### 11 Device and Documentation Support

#### 11.1 Device Support

#### 11.1.1 Development Support

TINA-TI SPICE-Based Analog Simulation Program, http://www.ti.com/tool/tina-ti

DIP Adapter Evaluation Module, http://www.ti.com/tool/dip-adapter-evm

TI Universal Operational Amplifier Evaluation Module, http://www.ti.com/tool/opampevm

#### 11.2 Documentation Support

#### 11.2.1 Related Documentation

A Quad of Independently Func Comparators (SNOA654)

#### 11.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### 11.4 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

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**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

#### 11.5 Trademarks

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#### 11.6 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### 11.7 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

### 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

www.ti.com 23-May-2025

#### PACKAGING INFORMATION

Orderable part number	Status	Material type	Package   Pins	Package qty   Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
LMV7239QDBVRQ1	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	ZBMX
LMV7239QDBVRQ1.A	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	ZBMX
LMV7239QM7/NOPB	Active	Production	SC70 (DCK)   5	1000   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	C42
LMV7239QM7/NOPB.A	Active	Production	SC70 (DCK)   5	1000   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	C42
LMV7239QM7X/NOPB	Active	Production	SC70 (DCK)   5	3000   LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	C42
LMV7239QM7X/NOPB.A	Active	Production	SC70 (DCK)   5	3000   LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	C42

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

### **PACKAGE OPTION ADDENDUM**

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#### OTHER QUALIFIED VERSIONS OF LMV7239-Q1:

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

### PACKAGE MATERIALS INFORMATION

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#### TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
	Dimension designed to accommodate the component thickness
	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LMV7239QDBVRQ1	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LMV7239QM7/NOPB	SC70	DCK	5	1000	178.0	8.4	2.25	2.45	1.2	4.0	8.0	Q3
LMV7239QM7X/NOPB	SC70	DCK	5	3000	178.0	8.4	2.25	2.45	1.2	4.0	8.0	Q3

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\*All dimensions are nominal

7 til difficilitie are memma								
Device	Package Type	Package Drawing	Pins SPQ		Length (mm)	Width (mm)	Height (mm)	
LMV7239QDBVRQ1	SOT-23	DBV	5	3000	208.0	191.0	35.0	
LMV7239QM7/NOPB	SC70	DCK	5	1000	208.0	191.0	35.0	
LMV7239QM7X/NOPB	SC70	DCK	5	3000	208.0	191.0	35.0	





#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
  2. This drawing is subject to change without notice.
  3. Reference JEDEC MO-203.

- 4. Support pin may differ or may not be present.5. Lead width does not comply with JEDEC.
- 6. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25mm per side





NOTES: (continued)

7. Publication IPC-7351 may have alternate designs.8. Solder mask tolerances between and around signal pads can vary based on board fabrication site.





NOTES: (continued)

- 9. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 10. Board assembly site may have different recommendations for stencil design.







#### NOTES:

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  2. This drawing is subject to change without notice.
  3. Reference JEDEC MO-178.

- 4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
- 5. Support pin may differ or may not be present.





NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.





NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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